

---

# High Performance Surface Mount Flip Chip LEDs

## Technical Data



**HP SunPower Series**  
**HSMA-H670/H690/H770/  
H790/R661/R761**  
**HSMC-H670/H690/H770/  
H790/R661/R761**  
**HSML-H670/H690/H770/  
H790/R661/R761**

---

### Features

- **High Brightness AlInGaP Material**
- **Improved Reliability through Elimination of Internal Wire Bond**
- **-40 to 85°C Operating Temperature Range**
- **Three Small Package Sizes**
- **Industry Standard 2.0 x 1.25 mm and 1.6 x 0.8 mm Footprints**
- **Right Angle Package**
- **Three Colors Available**
- **Diffused Optics**
- **Compatible with IR and Through-the-wave Solder Processes**
- **Available in 8 mm Tape on 178 mm (7") and 330 mm (13") Diameter Reels**

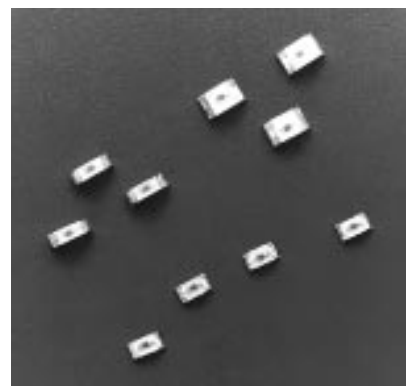
### Applications

- **Keypad Backlighting**
- **LCD Backlighting**
- **Symbol Backlighting**
- **Front Panel Indicator**

### Description

The HSMx-H670/H770, -H690/H790, and -R661/R761 combine high reliability surface mount flip chip LED construction with HP's bright AlInGaP material. These very small, bright LEDs have a high luminous efficiency capable of producing high light output over a wide range of drive currents. The 590 nm amber, 605 nm orange, and 626 nm red colors are available in three compact, low profile packages.

The HSMx-H670/H770 has the industry standard 2.0 x 1.25 mm footprint that is excellent for all around use. The HSMx-H690/



H790 has the industry standard 1.6 x 0.8 mm footprint, and its low 0.6 mm profile and wide viewing angle make this LED excellent for backlighting applications.

The HSMx-R661/R761 has a small 2.1 x 1.3 mm footprint and a low profile 0.7 mm height that makes this part ideal for LCD backlighting and sidelighting applications where space is at a premium. All packages are compatible with IR and convective reflow soldering processes. In addition, these parts are also compatible with through-the-wave soldering processes.

## Device Selection Guide

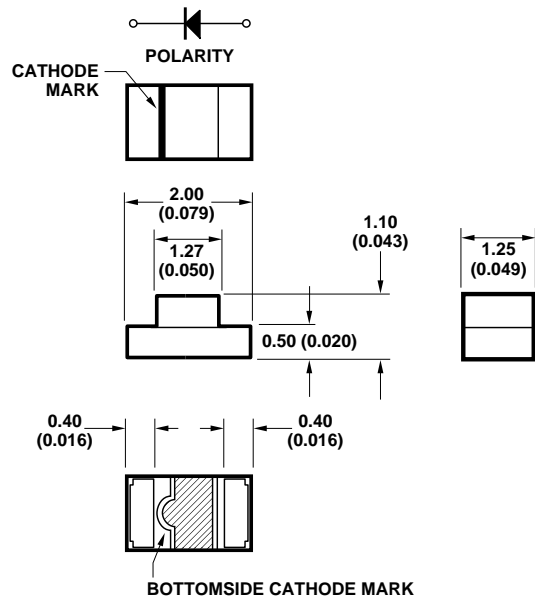
| Footprint (mm) <sup>[1][2]</sup> | Amber 590 nm |          | Orange 605 nm |          | Red 626 nm |          |
|----------------------------------|--------------|----------|---------------|----------|------------|----------|
|                                  | 7" Reel      | 13" Reel | 7" Reel       | 13" Reel | 7" Reel    | 13" Reel |
| 1.6 x 0.8 x 0.6                  | HSMA-H690    | -H790    | HSML-H690     | -H790    | HSMC-H690  | -H790    |
| 2.0 x 1.25 x 1.1                 | HSMA-H670    | -H770    | HSML-H670     | -H770    | HSMC-H670  | -H770    |
| 2.1 x 1.3 x 0.7 <sup>[3]</sup>   | HSMA-R661    | -R761    | HSML-R661     | -R761    | HSMC-R661  | -R761    |

### Notes:

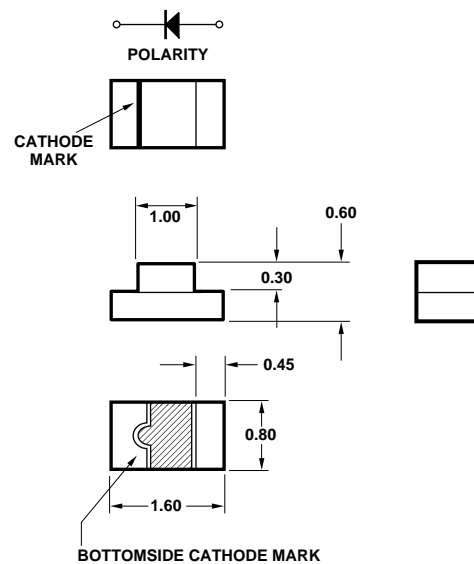
1. Dimensions in mm.
2. Tolerances  $\pm 0.1$  mm unless otherwise noted.
3. Right angle package.

## Package Dimensions

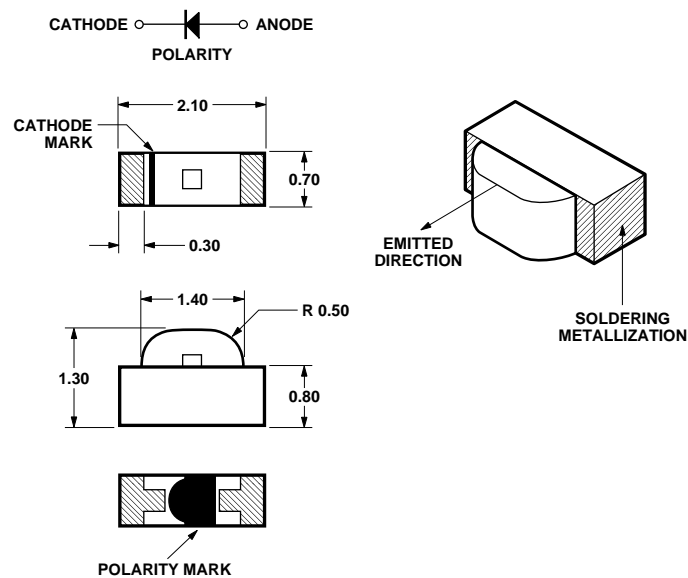
### HSMx-H670 Series



### HSMx-H690 Series



### HSMx-R661 Series



### Absolute Maximum Ratings at $T_A = 25^\circ\text{C}$

| Parameter                                       | Max. Rating | Units            |
|---|-------------|------------------|
| DC Forward Current <sup>[1]</sup>               | 20          | mA               |
| Power Dissipation                               | 50          | mW               |
| Reverse Voltage<br>( $I_R = 100\ \mu\text{A}$ ) | 5           | V                |
| Operating Temperature Range                     | -40 to 85   | $^\circ\text{C}$ |
| Storage Temperature Range <sup>[2]</sup>        | -40 to 85   | $^\circ\text{C}$ |

**Notes:**

- Derate linearly as shown in Figure 4 for temperatures above  $25^\circ\text{C}$ .
- Maximum temperature for tape and reel packaging is  $60^\circ\text{C}$ .

### Optical Characteristics at $T_A = 25^\circ\text{C}$

| Part No.               | Color  | Peak Wavelength<br>$\lambda_{\text{peak}}$ (nm)<br>Typ. | Color, Dominant Wavelength<br>$\lambda_d$ <sup>[2]</sup> (nm)<br>Typ. | Viewing Angle $2\theta_{1/2}$<br>Degrees <sup>[3]</sup><br>Typ. | Luminous Efficacy $\eta_v$<br>(lm/W) |
|------------------------|--------|---|---|---|--------------------------------------|
| HSMA-H6X0<br>HSMA-R661 | Amber  | 592   | 590   | 165   | 480                                  |
| HSML-H6X0<br>HSML-R661 | Orange | 607   | 605   | 165   | 370                                  |
| HSMC-H6X0<br>HSMC-R661 | Red    | 638   | 626   | 165   | 197                                  |

### Optical Characteristics at $T_A = 25^\circ\text{C}$ (Cont'd)

| Part No.               | Color  | Luminous Intensity<br>$I_v$ (mcd)<br>@ $I_F = 5\ \text{mA}$ |      | Luminous Intensity<br>$I_v$ (mcd)<br>@ $I_F = 20\ \text{mA}$ | Luminous Intensity<br>$I_v$ (mcd)<br>@ $I_F = 2\ \text{mA}$ |
|------------------------|--------|---|------|--|---|
|                        |        | Min.  | Typ. | Typ.   | Typ.  |
| HSMA-H6X0<br>HSMA-R661 | Amber  | 2.5   | 7.5  | 35   | 2.5   |
| HSML-H6X0<br>HSML-R661 | Orange | 2.5   | 7.5  | 35   | 2.5   |
| HSMC-H6X0<br>HSMC-R661 | Red    | 2.5   | 6.5  | 30   | 2.5   |

**Notes:**

- The dominant wavelength  $\lambda_d$  is derived from the CIE Chromaticity Diagram and represents the perceived color of the device.
- $\theta_{1/2}$  is the off-axis angle where the luminous intensity is 1/2 the peak intensity.
- Operation below  $I_F = 1\ \text{mA}$  is not recommended.

### Electrical Characteristics at $T_A = 25^\circ\text{C}$

| Part No.  | Color  | Forward Voltage $V_F$ (Volts)<br>@ $I_F = 5 \text{ mA}$ |      | Forward Voltage $V_F$ (Volts)<br>@ $I_F = 20 \text{ mA}$ |      | Reverse Breakdown $V_R$<br>(Volts)<br>@ $I_R = 100 \mu\text{A}$ | Capacitance $C$ (pF)<br>$V_F = 0$ ,<br>$f = 1 \text{ Mhz}$ |
|-----------|--------|---|------|--|------|---|--|
|           |        | Typ.  | Max. | Typ.   | Max. | Min.  | Typ.   |
| HSMA-H670 | Amber  | 1.9   | 2.2  | 2.0  | 2.4  | 5.0   | 20   |
| HSMA-H690 |        | 1.9   | 2.2  | 2.0  | 2.4  | 5.0   | 20   |
| HSMA-R661 |        | 1.9   | 2.2  | 2.0  | 2.4  | 5.0   | 20   |
| HSML-H670 | Orange | 1.9   | 2.2  | 2.0  | 2.4  | 5.0   | 20   |
| HSML-H690 |        | 1.9   | 2.2  | 2.0  | 2.4  | 5.0   | 20   |
| HSML-R661 |        | 1.9   | 2.2  | 2.0  | 2.4  | 5.0   | 20   |
| HSMC-H670 | Red    | 1.8   | 2.2  | 1.9  | 2.4  | 5.0   | 20   |
| HSMC-H690 |        | 1.8   | 2.2  | 1.9  | 2.4  | 5.0   | 20   |
| HSMC-R661 |        | 1.8   | 2.2  | 1.9  | 2.4  | 5.0   | 20   |

### Electrical Characteristics at $T_A = 25^\circ\text{C}$ (Cont'd)

| Part No.  | Color  | Thermal Resistance $R$<br>$\theta_{J-PIN}$ ( $^\circ\text{C/W}$ ) | Thermal Resistance $R$<br>$\theta_{J-A}$ ( $^\circ\text{C/W}$ ) |
|-----------|--------|---|---|
|           |        |   |   |
| HSMA-H670 | Amber  | 275   | 300   |
| HSMA-H690 |        | 350   | 400   |
| HSMA-R661 |        | 350   | 400   |
| HSML-H670 | Orange | 275   | 300   |
| HSML-H690 |        | 350   | 400   |
| HSML-R661 |        | 350   | 400   |
| HSMC-H670 | Red    | 275   | 300   |
| HSMC-H690 |        | 350   | 400   |
| HSMC-R661 |        | 350   | 400   |

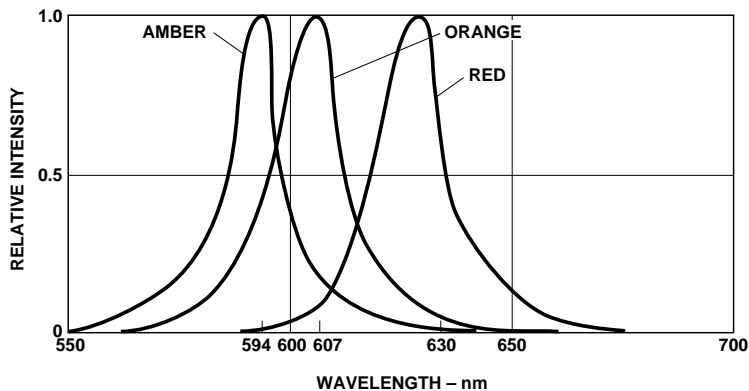


Figure 1. Relative Intensity vs. Wavelength.

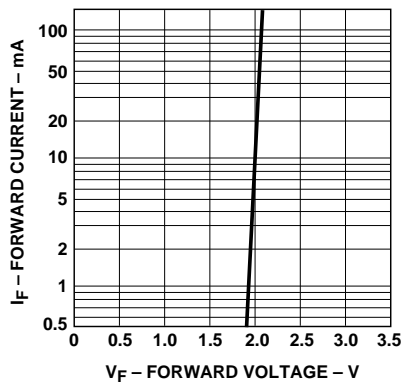


Figure 2. Forward Current vs. Forward Voltage.

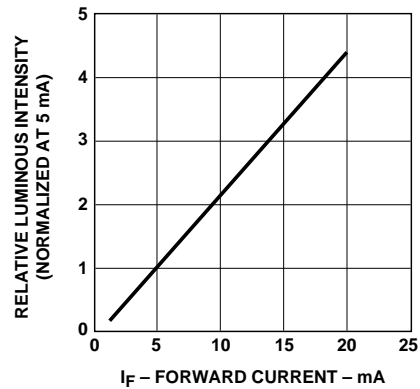


Figure 3. Relative Intensity vs. DC Forward Current (operation below 1 mA not recommended).

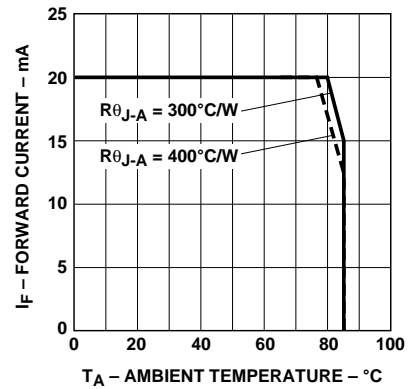


Figure 4. Maximum DC Current vs. Ambient Temperature.

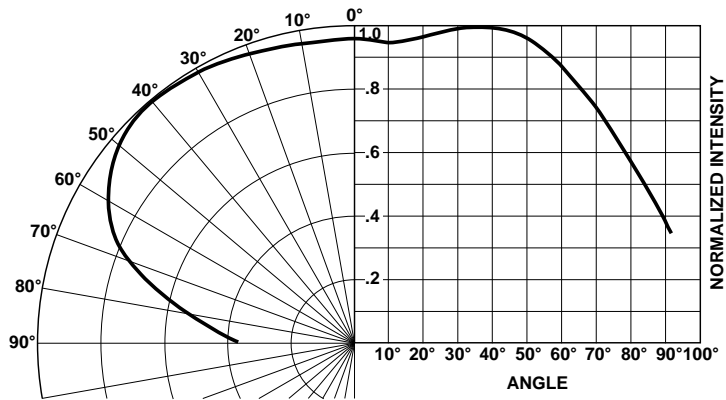


Figure 5. Intensity vs. Angle for HSMx-H670/H770 and HSMx-H690/H790.

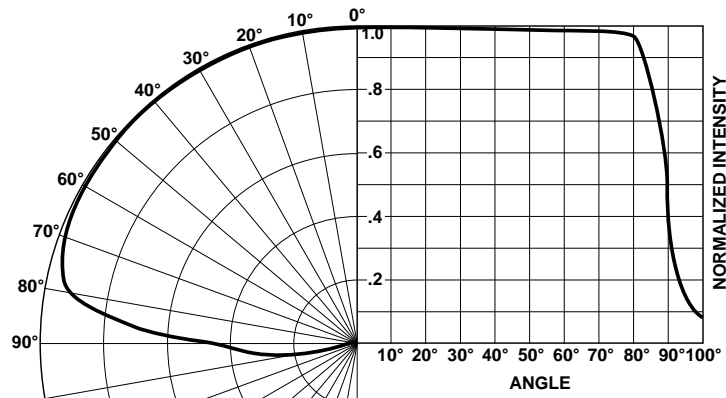


Figure 6. Intensity vs. Angle (Horizontal) for HSMx-R661/R761.

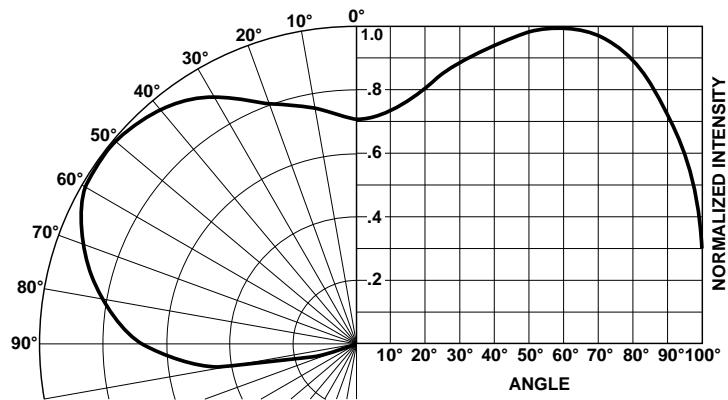
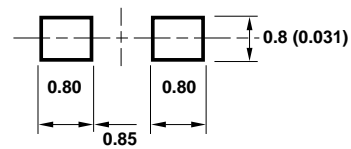
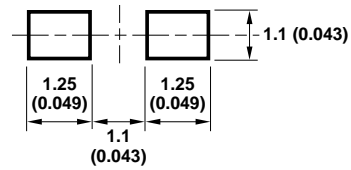


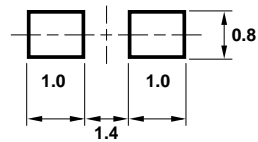
Figure 7. Intensity vs. Angle (Vertical) for HSMx-R661/R761.



HSMX-H690/H790 SERIES



HSMX-H670/H770 SERIES



HSMX-R661/R761 SERIES

Figure 8. Recommended Solder Pad Patterns.

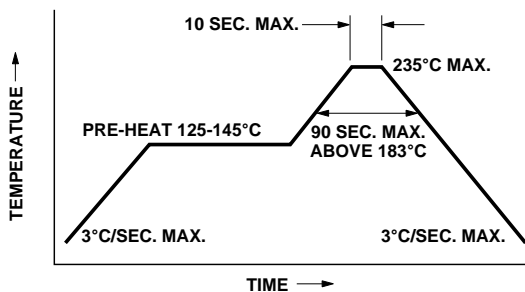


Figure 9. Recommended IR Reflow Soldering Profile.

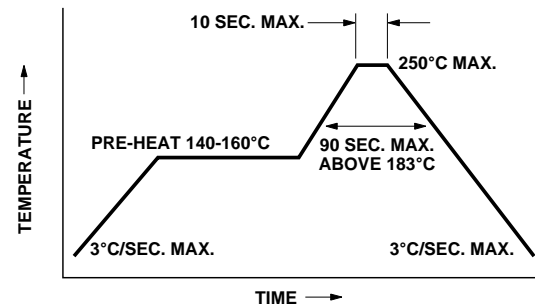


Figure 10. Recommended Wave Solder Profile.

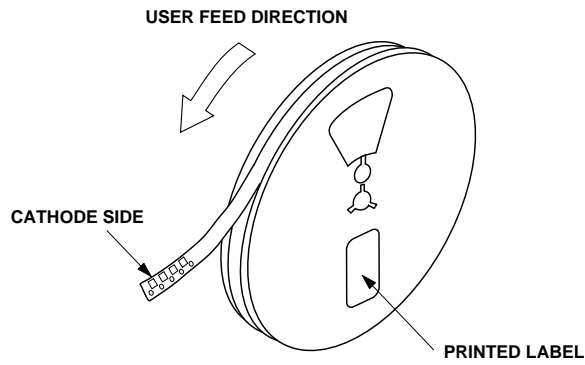


Figure 11. Reeling Orientation.

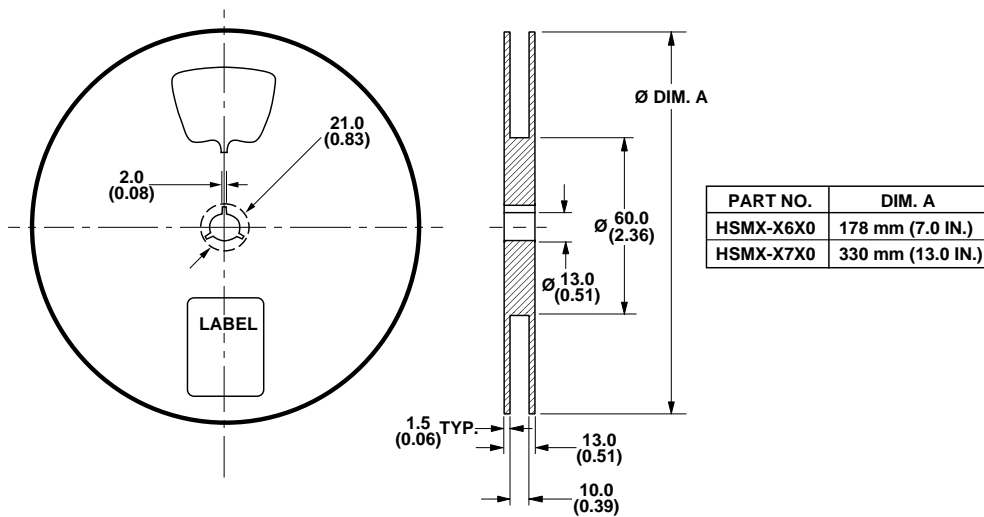


Figure 12. Reel Dimensions.





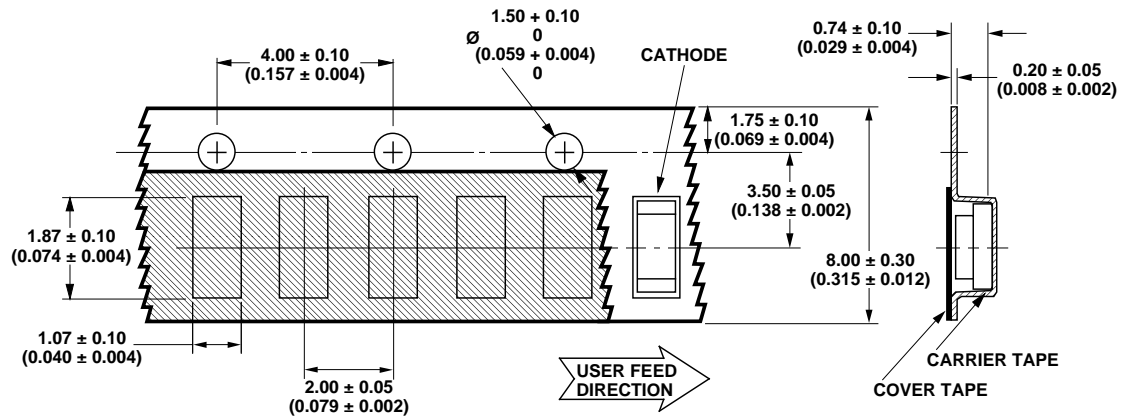


Figure 15. Tape Dimensions, HSMx-H690/H790 Series.

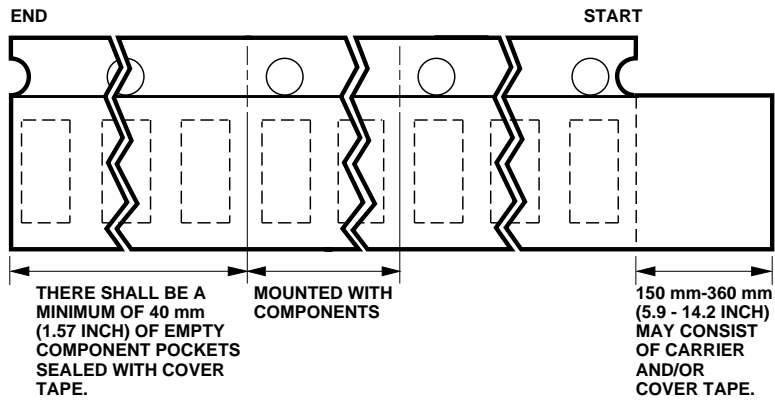


Figure 16. Tape Leader and Trailer Dimensions for HSMx-H690/H790 Series.

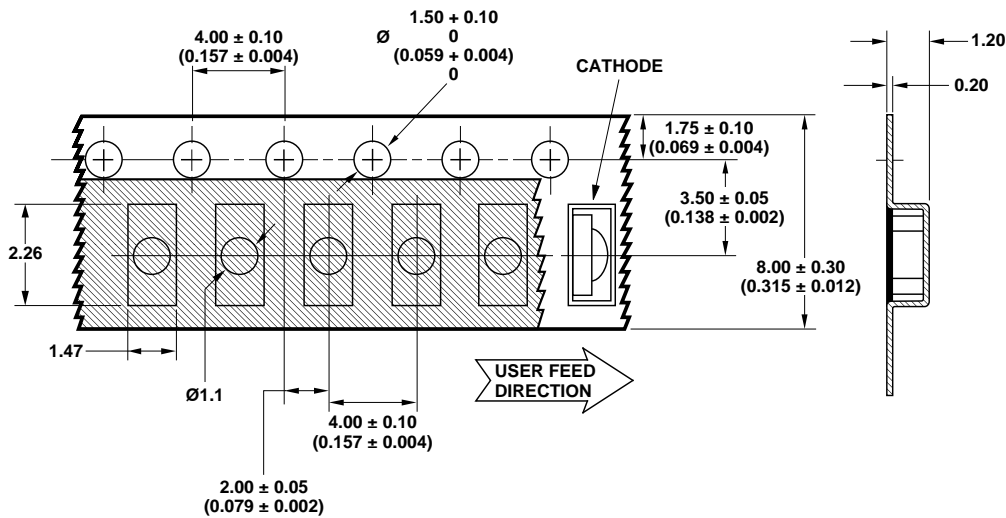


Figure 17. Tape Dimensions for HSMx-RX61.

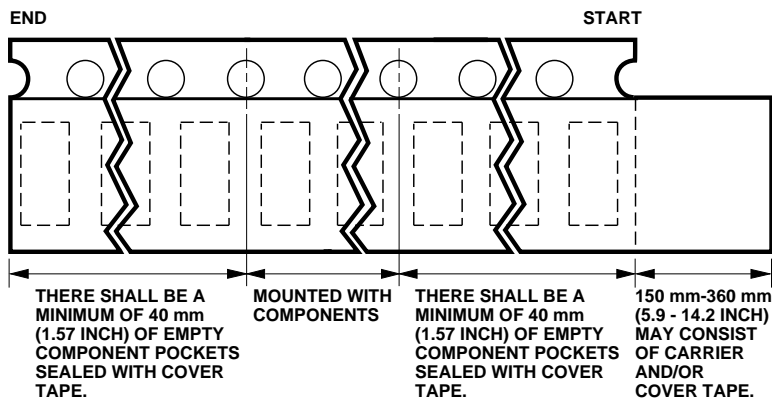


Figure 18. Tape Leader and Trailer Dimensions.

## Convective IR Reflow Soldering

For more information on IR reflow soldering, refer to Application Note 1060, *Surface Mounting SMT LED Indicator Components*.

[www.hp.com/go/led](http://www.hp.com/go/led)

For technical assistance or the location of your nearest Hewlett-Packard sales office, distributor or representative call:

**Americas/Canada:** 1-800-235-0312 or 408-654-8675

**Far East/Australasia:** Call your local HP sales office.

**Japan:** (81 3) 3335-8152

**Europe:** Call your local HP sales office.

Data subject to change.

Copyright © 1999 Hewlett-Packard Co.

Obsoletes 5968-1097E (8/98)

5968-3197E (2/99)